
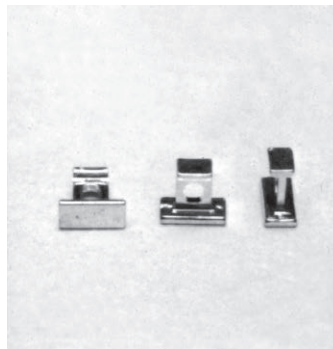


Test point for surface mounting (3.2 × 1.6 type)

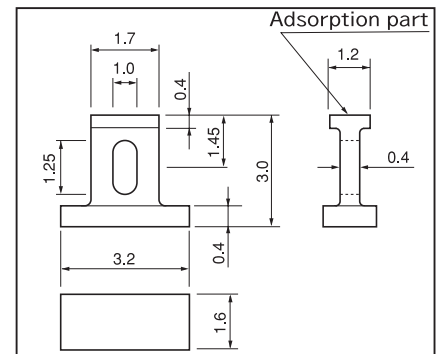
**HK-2 series**

- A chip mounter can be used for this test point.
- This can be also used for pattern heat dissipation.
- This is stored in an embossed tape.
- In the case of reflow with normal cream solder, the strength will be increased by using the land with a simple shape (  ) and the size of 3.2 × 1.6 or over.
- Material: Brass
- Finish HK-2-G: Gold plating over nickel base  
HK-2-S: Tin plating over nickel base

Part No.	Package
HK-2-G	1000pcs/reel
HK-2-S	1000pcs/reel



■ Dimension



■ Recommended land information

